

# APPROVAL SPECIFICATION

**PRODUCT NAME:**

**KOOMAG PN:** KMKC201610 Series

**CUSTOMER PN:**

## CUSTOMER RESPONSE

<input type="checkbox"/> Approval <input type="checkbox"/> Approval with the following changes <input type="checkbox"/> Reject		
APPROVED BY	SIGNATURE	DATE

## KOOMAG ENGINEERING SIGNATURE

APPROVED BY	CHECKED BY	ISSUED BY
DATE	DATE	DATE

深圳坤磁科技有限公司

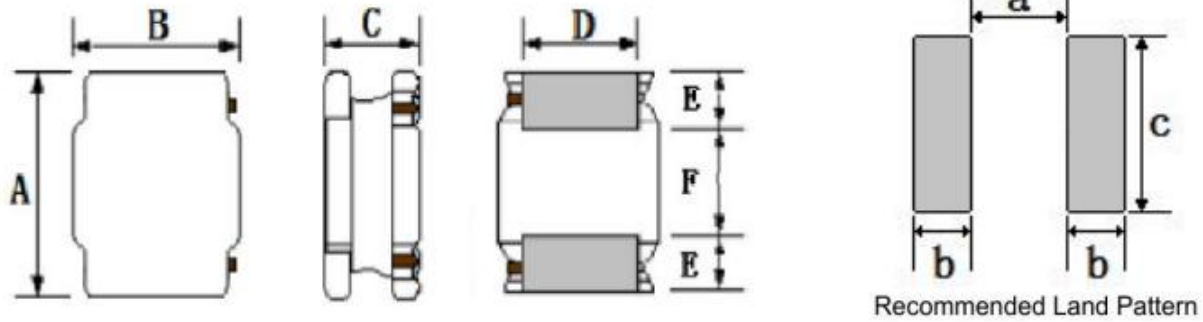
SHENZHEN KOOMAG TECHNOLOGY CO., LTD

Address: B503, Building B, HuaChuangDa Headquarters Building, Bao'an 49 District, Shenzhen

## General Description

This specification applies to the KMKC201610 Series of wire wound SMD power inductor.

## Appearance & Shape



## Dimension (Unit:mm)

NO	Series	A	B	C	D	E	F	a Typ.	b Typ.	c Typ.
1	KMKC201610	2.0±0.3	1.6±0.3	1.05 Max	1.2±0.2	0.6±0.2	0.8±0.2	0.70	0.70	1.70

## Part Number

KMKC	201610	-	1R5	
A	B		C	D

A:Series name (产品品名)

B:Dimensions (产品尺寸)

C:Inductance value (电感值) 1R5: 1.5μH 221: 220μH

D:Tolerance (误差值) M: ±20%; N: ±30%

## Electrical Characteristics

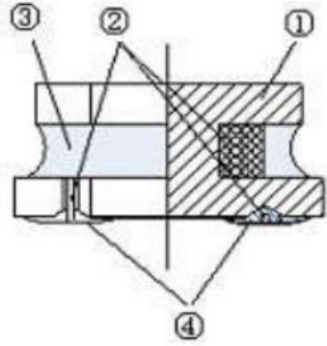
Please refer to Item 5.

- 1). Operating temperature range (individual chip without packing):  $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$  .
- 2). Storage temperature range (packaging conditions):  $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$  and RH 70% (Max.).
- 3). Rating DC current: Temperature rise( $\Delta T$ ) is  $40^{\circ}\text{C}$  approximately at Irms.
- 4). Saturation DC current: Inductance drop approximately 30% of L0 at Isat.

NO	Part Number	Inductance	DC Resistance		I <sub>sat</sub> (A)		I <sub>rms</sub> (A)		Marking
		100KHz/1.0V	Max.	Typ.	Max.	Typ.	Max.	Typ.	
	Units	( $\mu\text{H}$ )	$\Omega$	$\Omega$	A	A	A	A	
1	KMKC201610-R22N	0.22±30%	0.040	0.033	3.70	4.10	2.80	3.10	N/A
2	KMKC201610-R24N	0.24±30%	0.040	0.033	3.70	4.10	2.80	3.10	N/A
3	KMKC201610-R33N	0.33±30%	0.048	0.043	3.00	3.70	2.40	2.90	N/A
4	KMKC201610-R47N	0.47±30%	0.060	0.052	2.30	2.85	2.30	2.60	N/A
5	KMKC201610-R68N	0.68±30%	0.076	0.068	1.95	2.45	2.00	2.20	N/A
6	KMKC201610-1R0N	1.0±30%	0.114	0.104	1.65	1.85	1.45	1.60	N/A
7	KMKC201610-1R5M	1.5±30%	0.174	0.164	1.35	1.65	1.10	1.20	N/A
8	KMKC201610-2R2M	2.2±20%	0.265	0.232	1.20	1.45	1.05	1.15	N/A
9	KMKC201610-3R3M	3.3±20%	0.345	0.328	1.00	1.20	0.85	0.95	N/A
10	KMKC201610-4R7M	4.7±20%	0.480	0.430	0.75	0.90	0.70	0.80	N/A
11	KMKC201610-6R8M	6.8±20%	0.800	0.715	0.70	0.85	0.55	0.60	N/A
12	KMKC201610-8R2M	8.2±20%	0.940	0.818	0.68	0.78	0.53	0.60	N/A
13	KMKC201610-100M	10±20%	1.000	0.930	0.65	0.70	0.50	0.60	N/A
14									
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※Design as Customer's Requested Specifications. (可按顾客的特殊需求设计)

## Structure (The structure of product.)



NO	Components	Material
1	Core	Ni-Zn Ferrite
2	Wire	Polyurethane system enameled copper wire
3	Magnetic Glue	Epoxy resin and magnetic powder
4	Plating	AgNiSn or FeNiCu + Sn Alloy

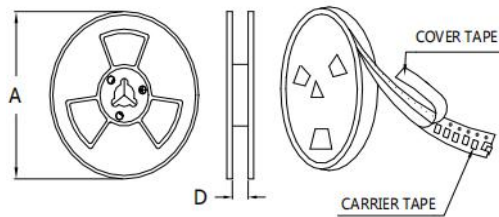
## Packaging(unit:mm)

1.Tape Dimensions(Unit:mm)

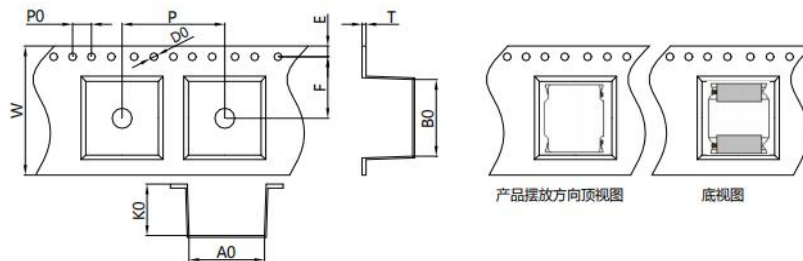
2.Reel

13" 盘

7" 盘



	13" 盘	7" 盘
A	$\Phi 330 \pm 2.0$	$\Phi 178 \pm 2.0$
D	8.5	



Size	Item	W	A0	B0	K0	P	T	E	F	D0	PO
201610	(mm)	$8.00 \pm 0.3$	$2.0 \pm 0.15$	$2.4 \pm 0.15$	$1.2 \pm 0.1$	$4.0 \pm 0.1$	$0.25 \pm 0.1$	$1.75 \pm 0.1$	$3.5 \pm 0.1$	$1.5 \pm 0.1$	$4.0 \pm 0.1$

Part No.	Tape	MPQ
201610	Embossed Tape	2000PCS

## Soldering Condition Sproduct

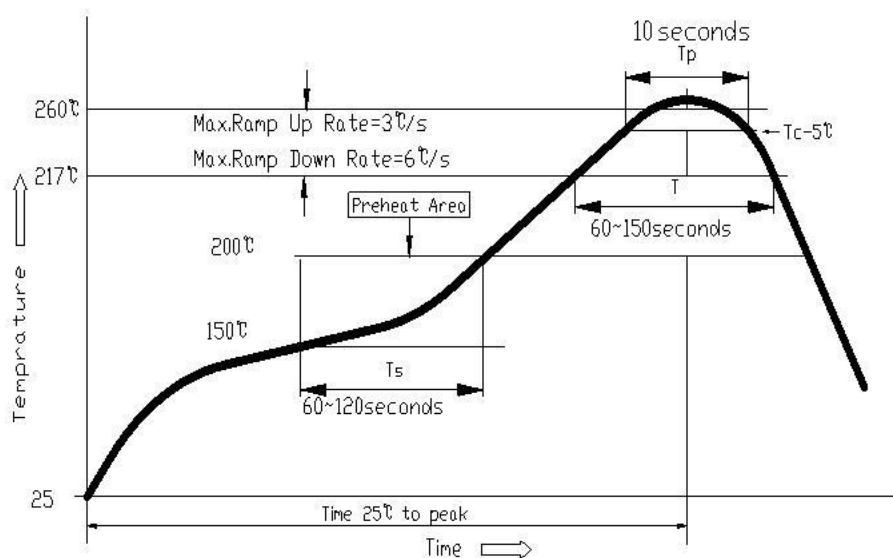
Applicable soldering process to the products is refl.

### 1.Soldering Materials

(1)Solder:Sn-3.0Ag-0.5Cu

(2)Flux:Use rosin-based flux,but not strongly acidic flux (with xhlorine exceeding 0.2wt%).Do not use water-soluble flux.

### 2.Reflow Soldering Profile



### 3.Solderin glron

Reworking with electric soldering iron must preheating at 150°C for 1 minute is required,and do not directly touch the core with the tip of the soldering iron.The reworking soldering conditions are as follows.

- ①Temperature of soldering iron tip:350°C ;
- ② Soldering iron power output:≤30W;
- ③ Diameter of soldering iron end:≤1.0mm;
- ④Soldering time:< 3s.

